



## Customer Information Notification

201701027I

**Issue Date:** 30-Jan-2017  
**Effective Date:** 31-Jan-2017

### Management Summary

NXP Semiconductors announces that the errata documentation for MC9S08AWXX 5M75B devices has been updated to Rev. 5, 01/2017.

### Change Category

<input type="checkbox"/> Wafer Fab Process	<input type="checkbox"/> Assembly Process	<input type="checkbox"/> Product Marking	<input type="checkbox"/> Test Location	<input type="checkbox"/> Design
<input type="checkbox"/> Wafer Fab Materials	<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Process	<input checked="" type="checkbox"/> Errata
<input type="checkbox"/> Wafer Fab Location	<input type="checkbox"/> Assembly Location	<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Equipment	<input type="checkbox"/> Electrical spec./Test coverage

## MSE9S08AW60\_5M75B Errata Update to Rev5

### Information Notification

NXP Semiconductors announces an errata update for the MC9S08AW60/48/32/16 Mask 5M75B devices associated with this notification. The errata sheet describes existing deviations from datasheet identified on current production devices. Potential implications on customer applications are described. The updated documents provide a detailed description of the changes.

#### 5M75B:

The following erratum was modified.

SE197-ICG-HGO=0

The following erratum was added.

SE198A-ICG-RANGE=0, HGO=1

The errata MSE9S08AW60\_5M75B revision 5 can be found at:

[http://www.nxp.com/products/automotive-products/microcontrollers-and-processors/arm-mcus-and-mpus/s32-arm-processors-microcontrollers/8-bit-general-purpose-aw60-48-32-16-mcus:S08AW?tab=Documentation\\_Tab](http://www.nxp.com/products/automotive-products/microcontrollers-and-processors/arm-mcus-and-mpus/s32-arm-processors-microcontrollers/8-bit-general-purpose-aw60-48-32-16-mcus:S08AW?tab=Documentation_Tab)

### Why do we issue this Information Notification

The errata documentation for MC9S08AWXX 5M75B has been updated to provide additional technical clarification on some device features.

### Identification of Affected Products

Product identification does not change

## Impact

There is no change to form, fit, function, or reliability.

## Data Sheet Revision

No impact to existing datasheet

## Additional information

Additional documents: [view online](#)

## Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please [contact NXP "Global Quality Support Team"](#).

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

<b>Name</b>	Sophia Gu
<b>Position</b>	Product engineer
<b>e-mail address</b>	<a href="mailto:yuanyuan.gu@nxp.com?subject=Support">mailto:yuanyuan.gu@nxp.com?subject=Support</a>

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.  
Customer Focus, Passion to Win.

NXP Quality Management Team.

## About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.